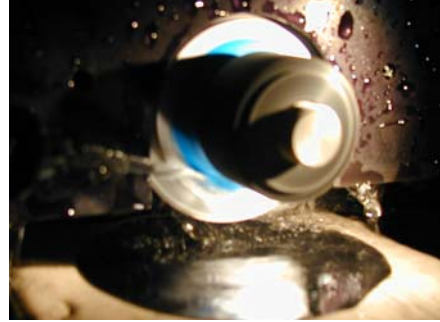
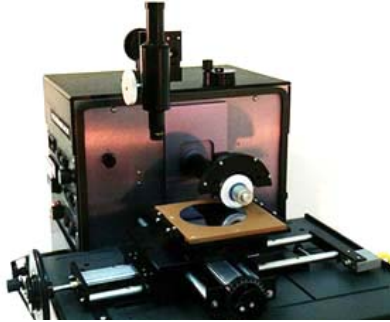


Diamond Saw

A diamond saw provides the means for dicing both thin and thick wafers and sheets of most materials into smaller squares and rectangles. Our diamond saw accepts all types of diamond blades to allow optimization of variables such as kerf loss and blade life. We use diamond saw in our lab to prepare samples that needs to be optically characterized.



Ultradice-2000 diamond saw